Schottky Barrier Diode

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

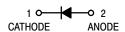
- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.28 Volts (Typ) @ $I_F = 1 \text{ mAdc}$
- Low Reverse Current



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40 V SCHOTTKY BARRIER DIODE



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Reverse Voltage	V_{RM}	40	V
Reverse Voltage	V_R	30	Vdc
Electrostatic Discharge	E _{SD}	HBM Class: 1C MM Class: A	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1.) T _A = 25°C Derate above 25°C	P _D	200 1.57	mW mW/°C
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

^{1.} FR-5 Minimum Pad



SOD-323 CASE 477 PLASTIC

MARKING DIAGRAMS



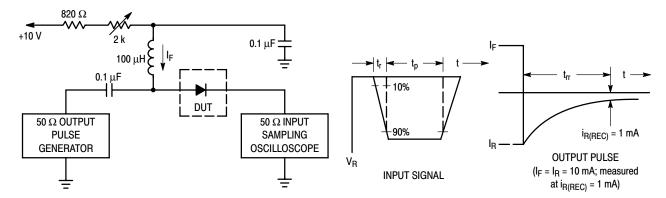
5E = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping	
RB751V40T1	SOD-323	3000/Tape & Reel	

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

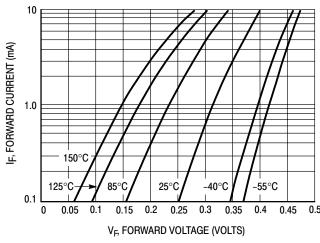
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage ($I_R = 10 \mu A$)	V _{(BR)R}	30	-	-	Volts
Total Capacitance (V _R = 1.0 V, f = 1.0 MHz)	C _T	_	2.0	2.5	pF
Reverse Leakage (V _R = 30 V)	I _R	_	300	500	nAdc
Forward Voltage (I _F = 1.0 mAdc)	V _F	_	0.28	0.37	Vdc



Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA. 2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA.

- 3. $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit



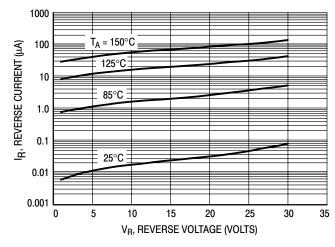


Figure 2. Typical Forward Voltage

Figure 3. Reverse Current versus Reverse Voltage

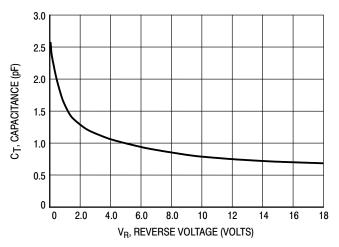
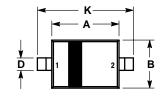
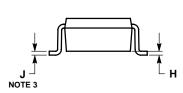


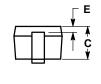
Figure 4. Typical Capacitance

PACKAGE DIMENSIONS

SOD-323 PLASTIC PACKAGE CASE 477-02 ISSUE B





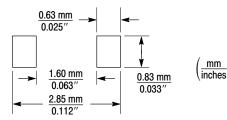


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.60	1.80	0.063	0.071
В	1.15	1.35	0.045	0.053
С	0.80	1.00	0.031	0.039
D	0.25	0.40	0.010	0.016
Е	0.15 REF		0.006 REF	
Н	0.00	0.10	0.000	0.004
J	0.089	0.177	0.0035	0.0070
K	2.30	2.70	0.091	0.106

STYLE 1: PIN 1. CATHODE 2. ANODE



SOD-323 Soldering Footprint

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